Product Information

Ultrason® E 2010 G6 Polyether Sulfone (PES)



Product Description

Ultrason E 2010 G6 is a 30% glass reinforced, medium viscosity injection molding PES grade with high rigidity and strength.

Applications

Typical applications include circuit braker parts, lamp holders, heat shields, impellers, and printer cartridges.

PLIVOIDAL	ICO Test Medical	Downson(se Verl
PHYSICAL	ISO Test Method	Property Value
Density, g/cm	1183	1.60
Mold Shrinkage, parallel, %	294-4	0.29
Mold Shrinkage, normal, %	294-4	0.58
Moisture, %	62	
(50% RH)		0.6
(Saturation)		1.6
RHEOLOGICAL	ISO Test Method	Property Value
Melt Volume Rate (360 C/10 Kg), cc/10min.	1133	25
MECHANICAL	ISO Test Method	Property Value
Tensile Modulus, MPa	527	
23C		10,000
Tensile stress at break, MPa	527	
23C		140
Tensile strain at break, %	527	
23C		1.9
Tensile Creep Modulus (1000h), MPa	899	8,300
IMPACT	ISO Test Method	Property Value
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Izod Notched Impact, kJ/m²	180	. reperty runne
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Izod Notched Impact, kJ/m²		
Izod Notched Impact, kJ/m² 23C	180	
Izod Notched Impact, kJ/m² 23C Charpy Notched, kJ/m²	180	8
Izod Notched Impact, kJ/m ² 23C Charpy Notched, kJ/m ² 23C	180	8
Izod Notched Impact, kJ/m² 23C Charpy Notched, kJ/m² 23C -30C	180 179	8
Izod Notched Impact, kJ/m² 23C Charpy Notched, kJ/m² 23C -30C Charpy Unnotched, kJ/m²	180 179	8 8 8
Izod Notched Impact, kJ/m² 23C Charpy Notched, kJ/m² 23C -30C Charpy Unnotched, kJ/m² 23C	180 179	8 8 8
Izod Notched Impact, kJ/m² 23C Charpy Notched, kJ/m² 23C -30C Charpy Unnotched, kJ/m² 23C -30C	180 179 179	8 8 8 42 45
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Ultrason® E 2010 G6



180

Dielectric Constant (1 MHz)	IEC 60250	4.3
Dissipation Factor (100 Hz)	IEC 60250	20
Dissipation Factor (1 MHz)	IEC 60250	100
Dielectric Strength, KV/mm	IEC 60243-1	37
UL RATINGS	UL Test Method	Property Value
Flammability Rating, 1.5mm	UL94	V-0
Relative Temperature Index, 1.5mm	UL746B	
Mechanical w/o Impact, C	62.762	190

Processing Guidelines

Electrical, C

Material Handling

Max. Water content: 0.02%

Ultrason pellets can absorb moisture very rapidly and must be dried before processing. A vacuum or dry air oven operating at 130-150 degC (266-302 degF) is recommended. Circulating air ovens are unsuitable. Drying time is dependent on moisture level, but the materials must be dried at least 4 hours. Further information concerning safe handling procedures can be obtained from the Material Safety Data Sheet. Alternatively, please contact your BASF representative.

Typical Profile

Melt Temperature 350-390 degC (662-734 degF) Mold Temperature 150-190 degC (302-374 degF) Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. Minimal back pressure should be utilized to prevent glass breakage.

Pressures

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.



